

PAD AREA
 KEEP OUT AREA
RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

备注:

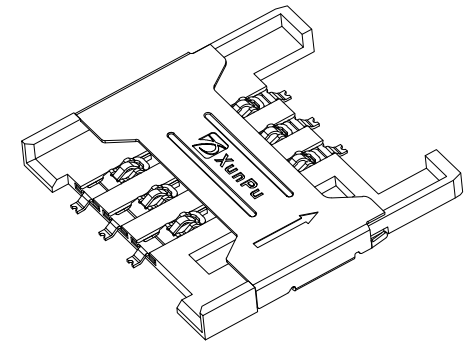
1.材质:

- 1.1胶芯:LCP UL94V-0
- 1.2端子:C2680,半金锡,触点镀金1U",雾锡80U"
- 1.3外壳:SUS201,镍底50U",焊接脚镀金1U"

2.主要特性:

- 2.1额定电流:0.5A
- 2.2接触阻抗:50MΩ MAX
- 2.3绝缘阻抗:100Ω MIN 100V DC
- 2.4耐压测试:100V AC
- 2.5沾锡性:温度235±5℃,时间5±0.5S
- 2.6单PIN正向应力:0.035KGF MIN
- 2.7使用寿命:7000次
- 2.8耐温性:烤箱测试:温度250±5℃,时间2分钟
- 2.9工作环境:温度:-30℃~+80℃;湿度:80% MAX

| MINI SIM CARD | |
|---------------|------------|
| Pin No. | NAME |
| C1 | VCC OF SIM |
| C2 | RST OF SIM |
| C3 | CLK OF SIM |
| C5 | GND OF SIM |
| C6 | VPP OF SIM |
| C7 | I/O OF SIM |
| C4/C8 | N/A |



| | | | |
|---------------------------------------|-----------|--|--|
| MANUFACTURE DWG | | 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd | |
| UNLESS OTHERWISE SPECIFIED TOLERANCES | | TITLE:MINI SIM CARD PUSH PULL 1.5H 防浪PIN 有档 PAR SIM-104 DWN YE CHKD APVD SCALE:1:1 UNIT:MM SIZE:A4 SHEET:1F1 REV:A | |
| DECIMALS: | ANGLES: | | |
| X.:±0.50 | X.':±5° | | |
| X.X:±0.25 | X.X':±3° | | |
| X.XX:±0.12 | X.XX':±1° | | |
| CUSTOMER COPY | | | |